

International Conference on Planarization/CMP Technology

# ICPT 2026

October 19-22, 2026

Science and Technology Convention Center,  
Seoul, South Korea

Sponsorship Prospectus

Organized by



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## I. INVITATION TO SPONSORSHIP & EXHIBITION

### Shape the Future of Semiconductor CMP at ICPT 2026

We are honored to invite your company to participate as a premier sponsor for The 21st International Conference on Planarization/CMP Technology (ICPT 2026), taking place from October 19th to 22nd, 2026, at the Science and Technology Convention Center in Seoul, South Korea.

For over two decades, ICPT has served as the global cornerstone for sharing groundbreaking advancements in CMP and planarization technologies. This year, we anticipate welcoming over 500 industry leaders, renowned researchers, and technical experts from around the world to the heart of the semiconductor industry, Seoul.

### Why Sponsor ICPT 2026?

Sponsoring ICPT 2026 is more than a branding opportunity; it is a strategic investment to position your organization at the forefront of the industry. As a sponsor, you will gain exclusive access to a highly targeted audience and enjoy distinct benefits designed to maximize your ROI:

- **Thought Leadership:** Deliver an exclusive keynote address to the entire assembly.
- **Prime Visibility:** Secure priority selection for exhibition booths and premium exposure across the venue.
- **Targeted Networking:** Engage directly with key decision-makers and potential clients through our structured networking sessions.

We offer a diverse range of sponsorship packages – from Diamond to Silver – tailored to meet your marketing and business objectives. We look forward to partnering with you to make ICPT 2026 a resounding success.

## II. Conference Information

<b>Title</b>	<b>International Conference on Planarization/CMP Technology (ICPT 2026)</b>
<b>Date</b>	<b>October 19 (Mon.) – 22 (Thu.), 2026</b>
<b>Place</b>	<b>Science and Technology Convention Center, Seoul, South Korea</b>
<b>Organized by</b>	<b>International Conference on Planarization/CMP Technology (ICPT) Korea Chemical Mechanical Planarization Users Group Meeting (CMPUGM) Korean Association for Particle and Aerosol Research (KAPAR)</b>
<b>Programs</b>	<b>Welcome Reception, Opening Ceremony, Banquet, Keynote Speeches, Oral &amp; Poster Sessions, Exhibition</b>
<b>Scale</b>	<b>- About 250 presentations - About 500~600 participants from 10 countries and regions</b>
<b>Website</b>	<b><a href="https://www.icpt2026.org/">https://www.icpt2026.org/</a></b>

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## III. Important Dates

<b>Abstract Submission Deadline</b>	<b>May 31, 2026</b>
<b>Notification of Abstract Acceptance</b>	<b>July 3, 2026</b>
<b>Early Bird Registration Deadline</b>	<b>August 31, 2026</b>

## IV. Conference Topics

ICPT 2026 offers a premier platform for global academic researchers, industry professionals, and engineers to share the latest advancements in Chemical Mechanical Polishing (CMP) and other planarization technologies.

We invite abstracts of original work covering a range of topics related to planarization, including:

- 01. Advanced Interconnect CMP (Metal)**
- 02. Dielectric & Hard materials CMP**
- 03. Advanced Packaging / 3D Integration CMP (Hybrid Cu Bonding, BSPDN, Wafer Thinning)**
- 04. Post-CMP Cleaning / Defect Engineering**
- 05. AI & ML for CMP / Process Control**
- 06. Metrology & Inspection / Equipment / Process Diagnostics**
- 07. CMP Consumables (Slurry, Abrasive, Pad, Conditioner, Filter etc.,)**
- 08. CMP Fundamentals (Tribology, Multiphysics Modeling etc.,)**
- 09. Nanomaterials & Surface Engineering for CMP**
- 10. Sustainable CMP / Manufacturing Readiness**

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## V. Sponsorship Information

We cordially introduce special opportunities for your company.

Your sponsorship in this exciting event will provide excellent opportunities for your company to expose high quality products and services to the experts from all parts of the world.

### Sponsorship Guideline

- To secure your booking and to ensure you gain the best possible promotional location, please fill out the Sponsorship Application form and e-mail it to the ICPT 2026 Secretariat ([icpt2026@icpt2026.org](mailto:icpt2026@icpt2026.org)) with a copy of business registration certificate.
- All sponsorship categories are filled **on first-come, first-served basis**.

### Application Deadline

- The deadline for the application is **July 31, 2026**.

### Cancellation Policy

- Before July 31, 2026: 100% of full payment will be refunded.
- Before August 31, 2026: 50% of full payment will be refunded.
- From September 1, 2026: Full payment will not be refunded.
- Cancellation of Sponsorship must be made in written format to the secretariat via e-mail.

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## Sponsorship Type

Benefits	1. Diamond	2. Platinum	3. Gold	4. Silver	5. Banquet Host
	USD 25,000	USD 15,000	USD 10,000	USD 7,500	Approx. USD 30,000
Complimentary Standard Conference Registrations	5 Persons	3 Persons	2 Persons	1 Person	Benefits and payment are subject to prior consultation with the Secretariat.
Complimentary Exhibition Booth (2 m x 2 m)	3 Booths (Priority Selection)	2 Booths (Second Selection)	1 Booths (Third Selection)	1 Booth	
Advertisement on the Program Book	1 Page	1 Page	1 Page	1/2 Page	
On-Stage Exposure	Exclusive Luncheon Keynote Speech (10 min.)	X	X	X	
Play the Promotional Movie on a Large TV	Mini-Movie (60 sec.) Advertisement in Conference Area	Mini-Movie (30 sec.) Advertisement in Conference Area	X	X	
Receive Conference Attendee Contact List*	O	O	O	O	
Logo Printing	Program Book	O	O	O	
	Screen at Session Room	O	O	O	
Web Banner (Logo + Link)	Official Website	O	O	O	
	E-Newsletter	O	O	O	

\*\* Conference attendees must opt-in to share contact information with sponsors/exhibitors.

## [Exhibition Booth Provided Items]

- Exhibition booth (including signage and lighting)
- 1 Desk
- 2 Chairs
- Basic Electricity: Single-phase 220 V, 2-outlet power strip

\*\* If additional power is required beyond the basic provision, a separate usage fee will be charged.

\*\* ICPT 2026 exhibition is only available as part of the sponsorship benefits.



※ Depending on the situation, the booth design may change.

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## Sponsorship Application Form

Please fill out the below application form, and send it back to the secretariat.

**ICPT 2026 Secretariat****E-mail: [icpt2026@icpt2026.org](mailto:icpt2026@icpt2026.org) / Tel: +82-42-472-7460**

### 1. Company Information

<b>Company Name</b>			
<b>Address</b>			
<b>President</b>			
<b>Contact Person Name</b>		<b>Job Title / Department</b>	
<b>Telephone</b>		<b>Mobile</b>	
<b>E-mail</b>			

### 2. Sponsorship Application

<b>Sponsorship Type</b>	<b>USD</b>	<b>Apply (Check "O")</b>
<b>Diamond</b>	<b>USD 25,000</b>	
<b>Platinum</b>	<b>USD 15,000</b>	
<b>Gold</b>	<b>USD 10,000</b>	
<b>Silver</b>	<b>USD 7,500</b>	
<b>Banquet Host</b>	<b>Subject to discussion</b>	

### 3. Account Information (Wire Transfer Only)

<ul style="list-style-type: none"> <li>■ Account Holder: GENICOM CO., LTD. ICPT 2026</li> <li>■ Account Number: 661-910023-71105</li> <li>■ Bank Name: KEB HANA BANK</li> <li>■ SWIFT Code: KOEXKRSE</li> <li>■ Bank Address: 35, EULJI-RO, JUNG-GU, SEOUL, SOUTH KOREA</li> </ul>
<ul style="list-style-type: none"> <li>■ Sponsorship Application Deadline: July 31, 2026</li> </ul>

Name of Applicant: \_\_\_\_\_ Date: \_\_\_\_\_

Signature: \_\_\_\_\_